

January 1997 Revised August 2004

## NC7ST08

# TinyLogic® HST 2-Input AND Gate

## **General Description**

The NC7ST08 is a single 2-Input high performance CMOS AND Gate, with TTL-compatible inputs. Advanced Silicon Gate CMOS fabrication assures high speed and low power circuit operation. ESD protection diodes inherently guard both inputs and output with respect to the  $V_{\rm CC}$  and GND rails. High gain circuitry offers high noise immunity and reduced sensitivity to input edge rate. The TTL-compatible inputs facilitate TTL to NMOS/CMOS interfacing. Device performance is similar to MM74HCT but with 1/2 the output current drive of HC/HCT.

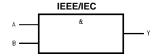
## **Features**

- Space saving SOT23 or SC70 5-lead package
- Ultra small MicroPak™ leadless package
- High Speed:  $t_{PD}$  6 ns (typ),  $V_{CC} = 5V$ ,  $C_L = 15$  pF,  $T_A = 25$ °C
- $\blacksquare$  Low Quiescent Power, I<sub>CC</sub> < 1  $\mu$ A, V<sub>CC</sub> = 5.5V
- $\blacksquare$  Balanced Output Drive; 2 mA I\_OL, -2 mA I\_OH
- TTL-compatible inputs

## **Ordering Code:**

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
NC7ST08M5X	MA05B	8S08	5-Lead SOT23, JEDEC MO-178, 1.6mm	3k Units on Tape and Reel
NC7ST08P5X	MAA05A	T08	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3k Units on Tape and Reel
NC7ST08L6X	MAC06A	NN	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel

## **Logic Symbol**



## **Pin Descriptions**

Pin Names	Description
A, B	Inputs
Y	Output
NC	No Connect

## **Function Table**

Y = AB

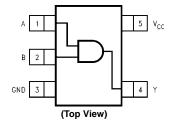
Inp	Output			
Α	A B			
L	L	L		
L	Н	L		
Н	L	L		
Н	Н	Н		

H = HIGH Logic Level

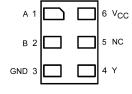
L = LOW Logic Level

## **Connection Diagrams**

### Pin Assignments for SC70 and SOT23



#### Pad Assignment for MicroPak



(Top Thru View)

 $\label{eq:total_cond} \mbox{TinyLogic@ is a registered trademark of Fairchild Semiconductor Corporation.} \\ \mbox{MicroPak}^{\mbox{\tiny TM}} \mbox{ is a trademark of Fairchild Semiconductor Corporation.} \\$ 

# Absolute Maximum Ratings(Note 1) Recommende

Supply Voltage (V $_{\rm CC}$ )  $$-0.5{\rm V}$  to +7.0V DC Input Diode Current (I $_{\rm IK}$ )

DC Input Voltage ( $V_{IN}$ ) -0.5V to  $V_{CC} + 0.5V$ 

DC Output Diode Current (I<sub>OK</sub>)

 $V_{OUT} < -0.5V$  –20 mA

 $V_{OUT} > V_{CC} + 0.5V$  +20 mA

Output Voltage (V $_{OUT}$ ) -0.5V to  $V_{CC}+0.5V$ 

DC Output Source or Sink Current

 $(I_{OUT})$  ±12.5 mA

DC V<sub>CC</sub> or Ground Current per

 $\begin{array}{ll} \mbox{Supply Pin (I_{CC} \ or \ I_{GND})} & \pm 25 \ \mbox{mA} \\ \mbox{Storage Temperature (T_{STG})} & -65 \ \mbox{°C to } +150 \ \mbox{°C} \end{array}$ 

Junction Temperature (T<sub>J</sub>) 150°C

Lead Temperature (T<sub>L</sub>);

(Soldering, 10 seconds) 260°C

Power Dissipation (PD) @+85°C

SOT23-5 200 mW SC70-5 150 mW

# Recommended Operating Conditions (Note 2)

Supply Voltage 4.5V to 5.5V

Input Voltage ( $V_{IN}$ ) 0.0V to  $V_{CC}$ Output Voltage ( $V_{OUT}$ ) 0V to  $V_{CC}$ Operating Temperature ( $T_A$ ) -40°C to +85°C

Input Rise and Fall Time (t<sub>r</sub>, t<sub>f</sub>)

 $V_{CC} = 5.0V$  0 ns to 500 ns

Thermal Resistance ( $\theta_{JA}$ )

SOT23-5 300°C/W

SC70-5 425°C/W

Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation of circuits outside the databook specifications.

Note 2: Unused inputs must be held HIGH or LOW. They may not float.

## **DC Electrical Characteristics**

Symbol	Parameter	v <sub>cc</sub>		$T_A = +25^{\circ}C$		T <sub>A</sub> = 40°C	$T_A = 40^{\circ}C \text{ to } +85^{\circ}C$		Conditions	
Cymbol		(V)	Min	Тур	Max	Min	Max	Units	Conditions	
V <sub>IH</sub>	HIGH Level Input Voltage	4.5-5.5	2.0			2.0		V		
V <sub>IL</sub>	LOW Level Input Voltage	4.5-5.5			0.8		0.8	V		
V <sub>OH</sub>	HIGH Level Output Voltage	4.5	4.4	4.5		4.4			$I_{OH} = -20 \mu A$	
		4.5	4.18	4.35		4.13		V	$I_{OH} = -2 \text{ mA}$	
									$V_{IN} = V_{IH}$	
V <sub>OL</sub>	LOW Level Output Voltage	4.5		0	0.1		0.1		$I_{OL} = 20 \mu A$	
		4.5		0.10	0.26		0.33	V	$I_{OL} = 2 \text{ mA}$	
									$V_{IN} = V_{IL}$	
I <sub>IN</sub>	Input Leakage Current	5.5			±0.1		±1.0	V	$0 \le V_{IN} \le 5.5V$	
I <sub>CC</sub>	Quiescent Supply Current	5.5			1.0		10.0	μΑ	$V_{IN} = V_{CC}$ or GND	
I <sub>CCT</sub>	I <sub>CC</sub> per Input	5.5			2.0		2.9	mA	One Input $V_{IN} = 0.5V$ or 2.4V,	
									Other Input V <sub>CC</sub> or GND	

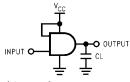
# **AC Electrical Characteristics**

Symbol	Parameter	V <sub>CC</sub>		$T_A = +25^{\circ}C$		$T_A = 40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions	Figure
Cymbol		(V)	Min	Тур	Max	Min	Max	Oiilla		Number
t <sub>PLH</sub> ,	Propagation Delay	5.0		4	12			no	C <sub>1</sub> = 15 pF	
$t_{PHL}$				6	17			ns	C <sub>L</sub> = 15 pr	
		4.5		6	16		20			Figures
				12	27		31		C 50 = F	1, 3
		5.5		5	14		18	ns	$C_L = 50 \text{ pF}$	
				11	26		30			
t <sub>TLH</sub> ,	Output Transition Time	5.0		4	10			ns	C <sub>L</sub> = 15 pF	
$t_{THL}$		4.5		11	25		31	ns	C <sub>1</sub> = 50 pF	Figures 1, 3
		5.5		10	21		26	115	о[ = 30 рі	., -
C <sub>IN</sub>	Input Capacitance	Open			10			pF		
C <sub>PD</sub>	Power Dissipation Capacitance	5.0		6				pF	(Note 3)	Figure 2

Note 3: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I<sub>CCD</sub>) at no output loading and operating at 50% duty cycle. (See Figure 2.) C<sub>PD</sub> is related to I<sub>CCD</sub> dynamic operating current by the expression:

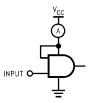
I<sub>CCD</sub> = (C<sub>PD</sub>)(V<sub>CC</sub>)(f<sub>IN</sub>) + (I<sub>CC</sub>static).

## **AC Loading and Waveforms**



 $C_L$  includes load and stray capacitance Input PRR = 1.0 MHz;  $t_w$  = 500 ns

FIGURE 1. AC Test Circuit



 $Input = AC \ Waveform; \ PRR = variable; \ Duty \ Cycle = 50\%$ 

FIGURE 2.  $I_{\rm CCD}$  Test Circuit

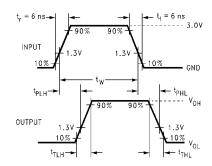
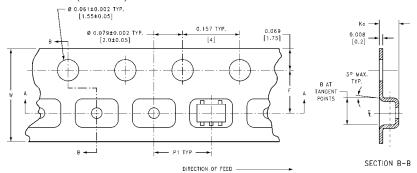


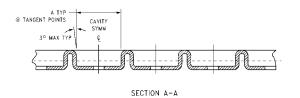
FIGURE 3. AC Waveforms

# Tape and Reel Specification TAPE FORMAT for SC70 and SOT23

TALE FORMATION COTTAINS COTES									
Package	Таре	Number	Cavity	Cover Tape					
Designator	Section	Cavities	Status	Status					
	Leader (Start End)	125 (typ)	Empty	Sealed					
M5X, P5X	Carrier	3000	Filled	Sealed					
	Trailer (Hub End)	75 (typ)	Empty	Sealed					

### TAPE DIMENSIONS inches (millimeters)

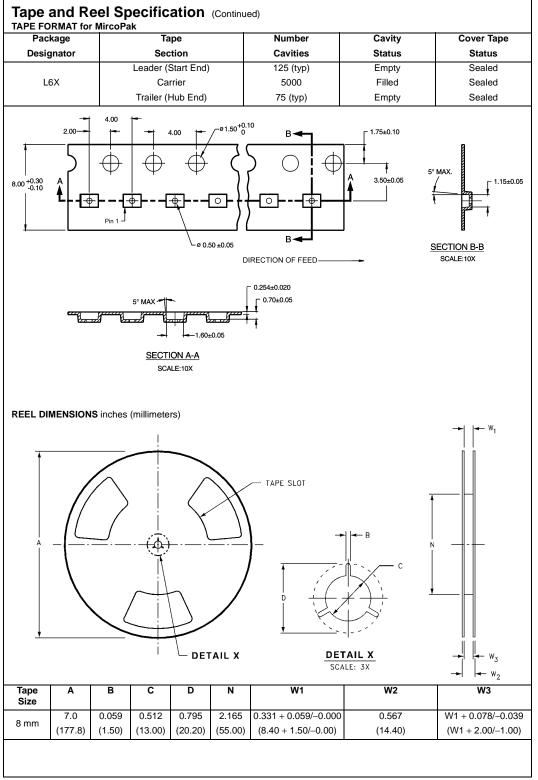


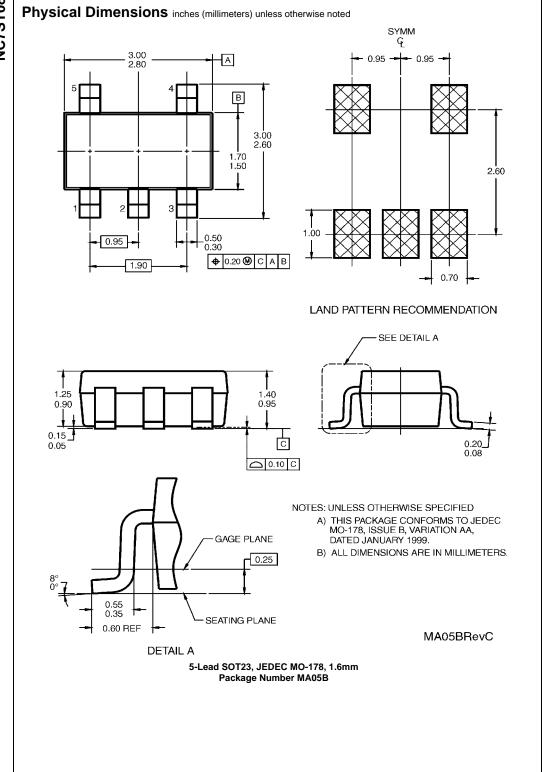


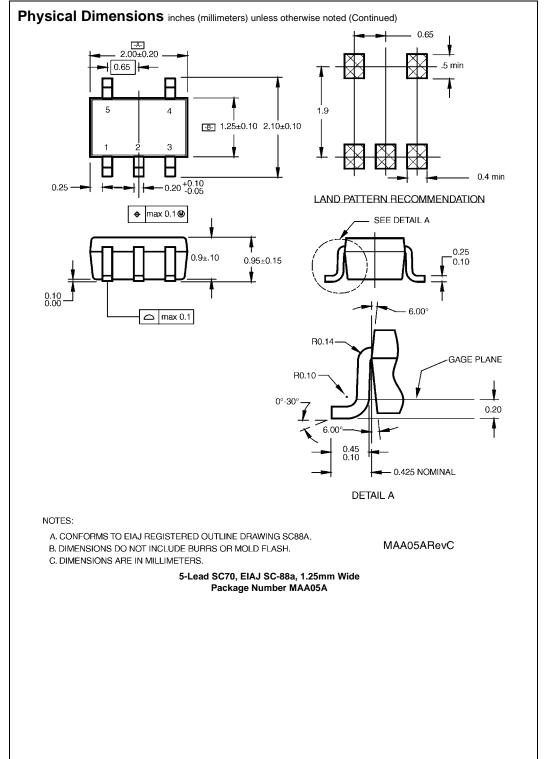


					BEND RADIUS NOT TO SCALE				
Package	Tape Size	DIM A	DIM B	DIM F	DIM K <sub>o</sub>	DIM P1	DIM W		

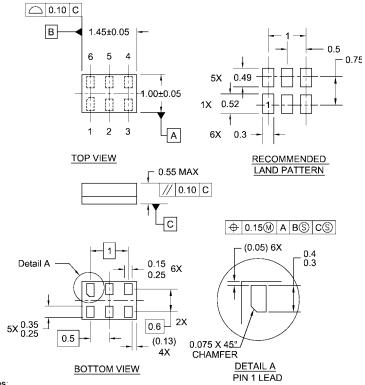
SC70-5	8 mm	0.093	0.096	$0.138 \pm 0.004$	$0.053 \pm 0.004$	0.157	$0.315 \pm 0.004$
SOT23-5		(2.35)	(2.45)	$(3.5 \pm 0.10)$	$(1.35 \pm 0.10)$	(4)	$(8 \pm 0.1)$
		0.130	0.130	$0.138 \pm 0.002$	$0.055 \pm 0.004$	0.157	$0.315 \pm 0.012$
	8 mm	(3.3)	(3.3)	$(3.5 \pm 0.05)$	$(1.4 \pm 0.11)$	(4)	$(8 \pm 0.3)$







## Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



#### Notes:

- 1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

6-Lead MicroPak, 1.0mm Wide Package Number MAC06A

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